SD	F	CI	F	CA.	TIC	M	C
JE	_	\mathbf{c}		CA		/ I N	•

CUSTOMER : CDE012

SAMPLE CODE : SH800480T032-ZHA07

MASS PRODUCTION CODE : PH800480T032-ZHA07

SAMPLE VERSION : 01

SPECIFICATIONS EDITION : 002

DRAWING NO. (Ver.) : LMD-PH800480T032-ZHA07 (Ver.002)

PACKAGING NO. (Ver.) : PKG-PH800480T032-ZHA07 (Ver.001)

Customer Approved

Date:

Approved	Checked	Designer
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2023.11.22

- □ Preliminary specification for design input
- Specification for sample approval

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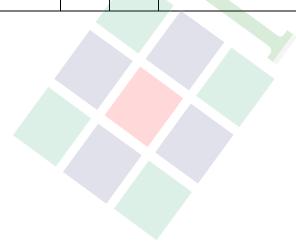
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Http://www.powertip.com.tw



History of Version

Date (mm / dd / yyyy)	<u>Ver.</u>	Edi.	<u>Description</u>	<u>Page</u>	<u>Design</u> <u>by</u>
11/17/2023	01	001	Preliminary.	-	Yuan
11/22/2023	01	002	Frist Sample ADD DIM	- Appendix	Yuan
					-





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1. SPECIFICATIONS

1.1 Features

<u>Item</u>	Standard Value			
Display Resolution	800 *3 (RGB) * 480 Dots			
LCD Type	IPS, Normally Black, Transmissive type			
Screen size(inch)	7 inch			
Surface treatment	Anti-Glare			
Color configuration	R.G.B. Vertical Stripe			
Weight	186g			
Interface	Parallel RGB (Data), SPI (Configuration), DE mode			
Driver IC	HimaxHX8249-A02 HimaxHX8678-C			
ROHS	THIS PRODUCT CONFORMS THE ROHS OF PTC Detail information please refer website: http://www.powertip.com.tw/news_detail.php?Key=1&clD=1			

1.2 Mechanical Specifications

<u>Item</u>	<u>Standard Value</u>	<u>Unit</u>
Outline Dimension	164.4 (W) * 105.9 (L) * 5.7 (H)	mm

LCD panel

<u>Item</u>	<u>Standard Value</u>	<u>Unit</u>
View Area	153.40 (W) * 92.44 (L)	mm
Active Area	152.40 (W) * 91.44 (L)	mm

Note: For detailed information please refer to LCM drawing.



1.3 Absolute Maximum Ratings

Module

<u>ltem</u>	<u>Symbol</u>	Condition	Min.	Max.	Unit	Remark
Power Supply for TFT Panel	V_{DD}	GND=0V	-0.3	3.96	V	
Power Supply for Backlight Unit	Vcc	GND=0V	-0.3	+20.0	V	_
Operating Temperature	Тор	-	-20	+70	°C	
Storage Temperature	T _{ST}	-	-30	+80	°C	

The absolute maximum rating values of this product are not allowed to be exceeded at any time. Should a module be used with any of the absolute maximum ratings exceeded, the characteristics of the module may not be recovered, or in an extreme case, the module may be permanently destroyed.

Note 1: Ts is the temperature of panel's surface

Note 2: Ta is the ambient temperature of samples

1.4 DC Electrical Characteristics

Module

<u>ltem</u>	Symbol	Condition	Min.	Typ.	Max.	<u>Unit</u>
Power Supply for TFT Panel	VDD	GND=0V	3.0	3.3	3.6	V
Power Supply for Backlight Unit	VCC	GND=0V	5	12	15	V
Input Voltage for	ViH	GND=0V	0.7VDD	-	VDD	
TFT Panel	VIL	GND=0V	0	-	0.3VDD	V
Supply Current for TFT Panel	IDD	IDD@VDD=3.3V	1	30	45	mA
Supply Current for Backlight Unit	ICC	ICC@VCC=5V	1	0.8	1.2	A
Supply Current for Backlight Unit	ICC	ICC@VCC=12V	ı	0.3	0.45	A
Input Voltage for	VPH	GND=0V	1.2	-	-	V
PWM Signal	VPL	GND=0V	-	-	0.4	V
Dimming Clock Rate	fP	GND=0V	0.1	-	8	KHz



1.5 Optical Characteristics

VDD=3.3V, Ta=25°C

<u>ltem</u>	<u>Symbol</u>		Condition	Min.	<u>Typ.</u>	Max.	<u>unit</u>	
Response time	Tr	+Tf	Ta = 25°C θX, θY = 0°	-	30	45	ms	Note 2
	Тор	θΥ+		1	80	-		
Viowing angle	Bottom	θΥ-	CR ≥ 10	-	80	•	Dog	Note 4
Viewing angle	Left	θΧ-	CR 2 10	1	80	1	Deg.	Note 4
	Right	θΧ+			80	ľ		
Contrast ratio)	CR		650	800	-	>	Note 3
	\//bito	Х		0.25	0.30	0.35	-	
	White	Υ		0.29	0.34	0.39		
0 1 1015	Red	Х	Ta = 25°C θX , θY = 0°	0.59	0.64	0.69		
Color of CIE Coordinate		Υ		0.30	0.35	0.40		Note1
(With B/L)	Green	Χ		0.26	0.31	0.36		Note
(*************************************		Υ		0.59	0.64	0.69		
	Blue	X		0.08	0.13	0.18		
	Dide	Y		0.01	0.06	0.11		
Average Brightness Pattern=white display (With LCD)*1	hite display IV		VCC=12.0V PWM="High" (Duty=100%)	800	1000	ı	cd/m²	Note1
Uniformity (With LCD)*2	ΔB		VCC=12.0V PWM="High" (Duty=100%)	70	-	-	%	Note1



Note 1:

*1: △B=B(min) / B(max) * 100%

*2: Measurement Condition for Optical Characteristics:

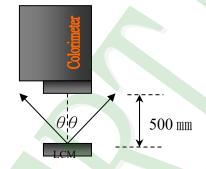
a: Environment: 25°C±5°C / 60±20%R.H, no wind, dark room below 10 Lux at typical lamp current and typical operating frequency

b: Measurement Distance: 500 ± 50 mm, $(\theta = 0^{\circ})$

c: Equipment: TOPCON BM-7 fast, (field 1°), after 10 minutes operation

d: The uncertainty of the C.I.E coordinate measurement ±0.01, Average Brightness ± 4%





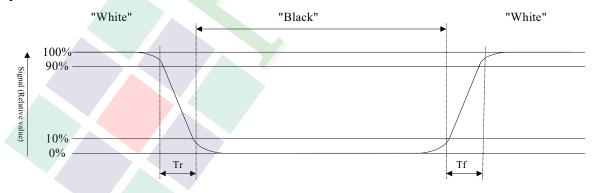
Colorimeter=BM-7 fast

To be measured at the center area of panel with a viewing cone of 1° by Topcon luminance meter BM-7, after 10 minutes operation (module)

Note 2: Definition of response time:

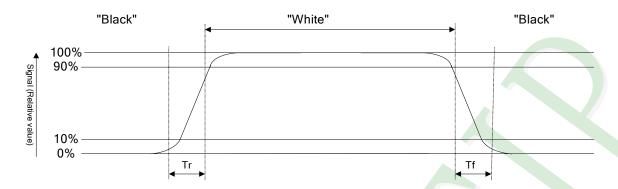
The output signals of photo detector are measured when the input signals are changed from "black" to "white" (falling time) and from "white" to "black" (rising time), respectively. The response time is defined as the time interval between the 10% and 90% of Amplitudes. Refer to figure as below:

Normally White





Normally Black



Note 3: Definition of contrast ratio:

Contrast ratio is calculated with the following formula

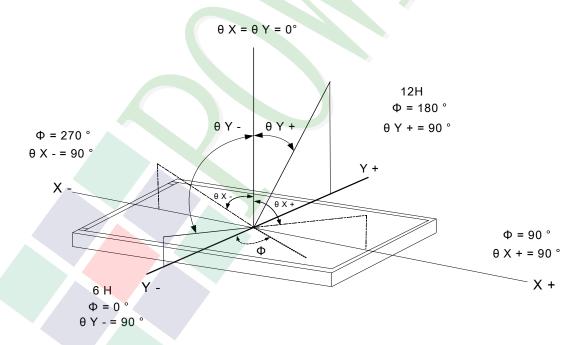
Photo detector output when LCD is at "White" state

Contrast ratio (CR) =

Photo detector output when LCD is at "Black" state

Note 4: Definition of viewing angle:

Refer to figure as below:





1.6 Backlight Characteristics

Maximum Ratings

<u>ltem</u>	<u>Symbol</u>	Min.	Max.	<u>Unit</u>	<u>Remark</u>
LED Forward Current	lf	-	600	mA	Don
LED Reverse Voltage	VR	-	1.2	V	Per

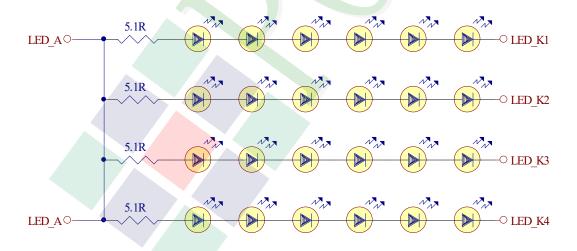
Electrical / Optical Characteristics

<u>Item</u>	<u>Symbol</u>	Min.	<u>Typ.</u>	Max.	<u>Unit</u>	<u>Remark</u>
LED Voltage	VL	14.9	16.6	19.1	V	Note1
LED Current	lι	-	200		mA	-
LED life time	-	50,000	-	1	Hr	Note2

Note 1: The LED Supply Voltage is defined by the number of LED at Ta=25℃ and I∟=200 mA

Note 2: The "LED life time" is defined as the module brightness decrease to 50% original brightness at

Ta=25 $^{\circ}$ C and IL =200 mA. The LED life time could be decreased if operating IL is larger than 200mA





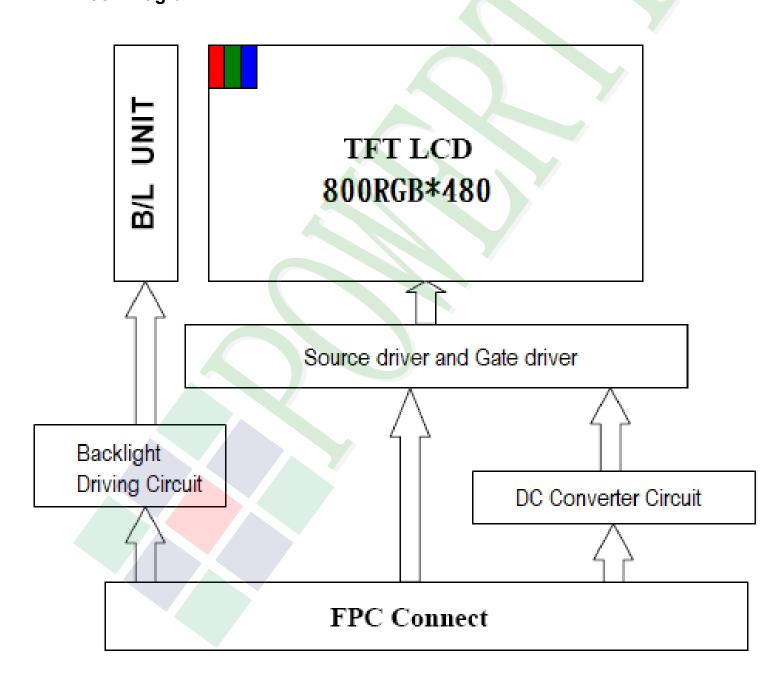
2. Module Structure

2.1 Counter Drawing

2.1.1 LCM Mechanical Diagram

* See Appendix

2.1.2 Block Diagram





2.2 Interface Pin Description

TFT LCM Interface

Pin#	<u>Name</u>	<u>Description</u>
1	GND	Power ground.
2	VDD	Power for Digital Circuit.
3	VDD	Power for Digital Circuit.
4	VCC	Power For LED backlight.
5	VCC	Power For LED backlight.
6	PWM	Shutdown & Dimming control input for backlight. Do not allow this pin to float. "Hi" =100%, "Low" = 0%.
7	GND	Power ground.
8	R0	Red Data.
9	R1	Red Data.
10	R2	Red Data.
11	R3	Red Data.
12	GND	Power ground.
13	R4	Red Data.
14	R5	Red Data.
15	R6	Red Data.
16	R7	Red Data.
17	GND	Power ground.
18	G0	Green Data.
19	G1	Green Data.
20	G2	Green Data.
21	G3	Green Data.
22	GND	Power ground.
23	G4	Green Data.
24	G5	Green Data.
25	G6	Green Data.
26	G7	Green Data.
27	GND	Power ground.
28	В0	Blue Data.
29	B1	Blue Data.



Pin#	<u>Name</u>	<u>Description</u>
30	B2	Blue Data.
31	В3	Blue Data.
32	GND	Power ground.
33	B4	Blue Data.
34	B5	Blue Data.
35	B6	Blue Data.
36	B7	Blue Data.
37	GND	Power ground.
38	HS	Line synchronization signal. Horizontal Sync Input.
39	VS	Frame synchronization signal. Vertical Sync Input.
40	GND	Power ground.
41	DE	Data Enable
42	GND	Power ground.
43	DCLK	Sample clock. Data will be latched at the falling edge of DCLK.
44	GND	Power ground.
45	CS / ID1	Serial communication chip selection/ID[4:1]These pins select LCM type. See NOTE1
46	SDIN / ID2	Serial communication data/ ID[4:1]These pins select LCM type. See NOTE1
47	SCK / ID3	Serial communication clock/ ID[4:1]These pins select LCM type. See NOTE1
48	DISPLAY CONTROL / ID4	Display Enable(Hi Active)./ ID[4:1]These pins select LCM type. See NOTE1
49	/RESET	Global Reset (Low Active).
50	GND	Power ground.

Note1:

ID Pins Definition:

	PIN 45 ID1	PIN 46 ID2	PIN 47 ID3	PIN 48 ID4
3.5" Module	X	0	0	X
4.3" Module	X	1	0	X
5.0" Module	X	0	1	X
7.0" Module	X	1	1	X

^{1.} Resistor = 10k ohm

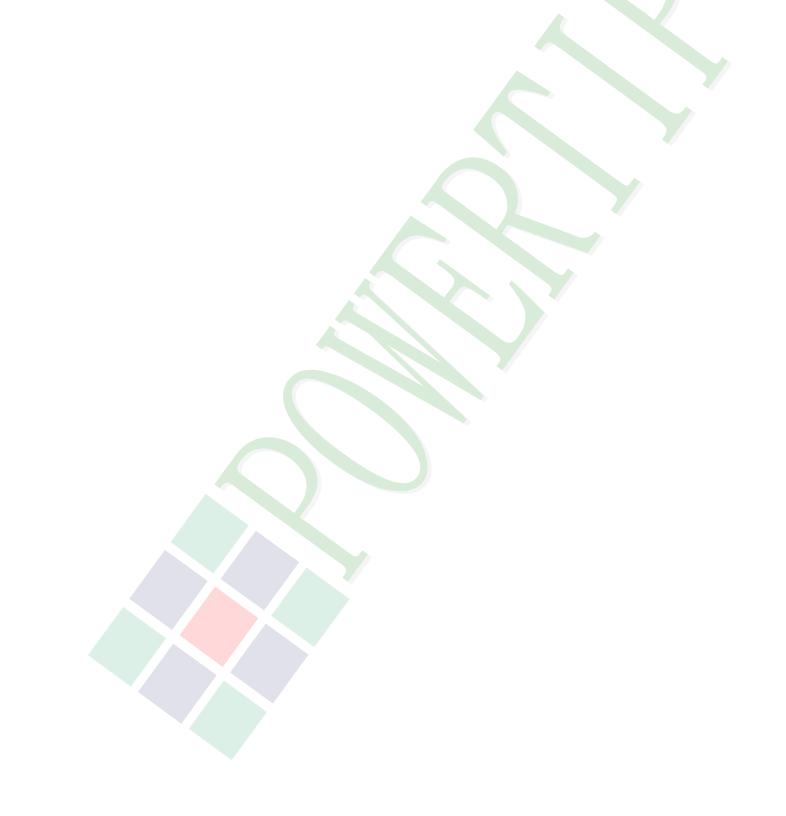
^{2. &}quot;X" = No use



2.3 Timing Characteristics

2.3.1 RGB Mode Selection Table

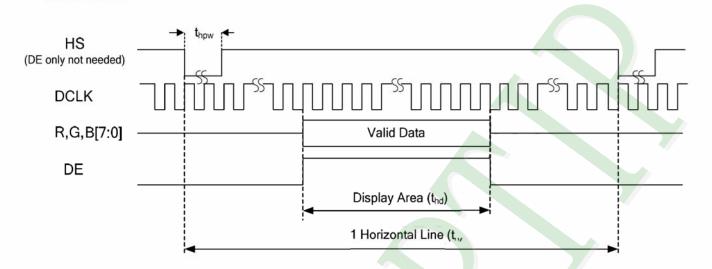
RGB Mode Selection Table	DCLK	HSYNC	VSYNC	<u>DE</u>
DE Mode	Input	GND	GND	Input





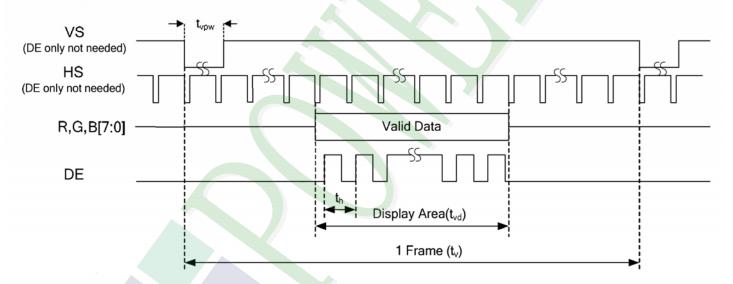
2.3.2 Parallel RGB DE Mode

Horizontal



Horizontal input timing at DE only mode

Vertical



Vertical input timing at DE only mode



2.3.3 Parallel 24-bit RGB Input Timing

<u>ltem</u>	Symbol	<u>Min</u>	Typ.	Max	<u>Unit</u>	<u>Note</u>
DCLK Frequency	FDCLK	25.2	27.2	30.5	MHz	-
Horizontal valid data	thd		800		-	-
1 horizontal line	th	856	860	920	DCLK	-
Vertical valid data	tvd		480		-	-
1 vertical field	tv	490	528	552	Н	-

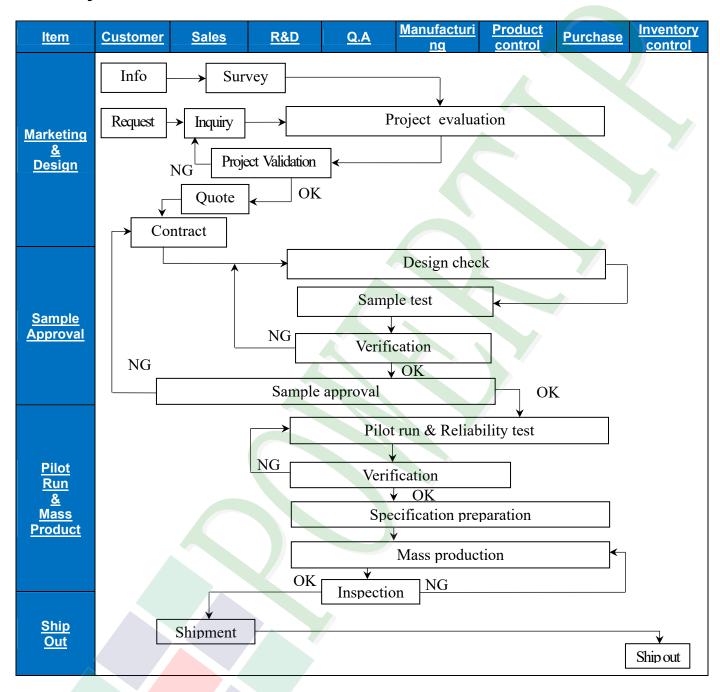
Note:

- (1) thd is same to Hactive, and tvd is same to Vactive in chapter 5.1.
- (2) DCLK frequency min/max value is base on frame rate 60 Hz

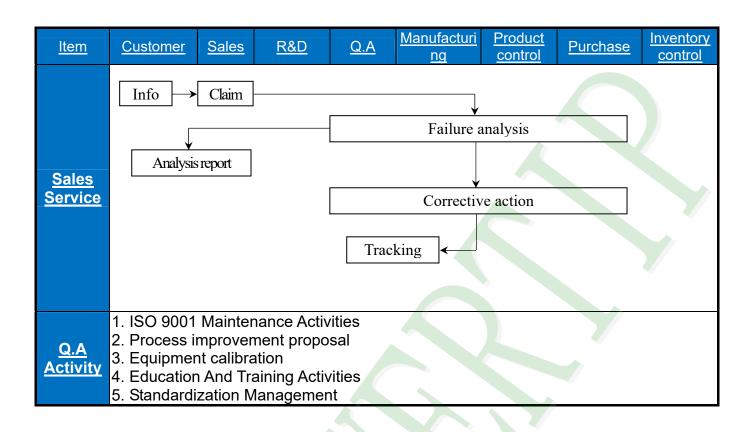


3. Quality Assurance System

3.1 Quality Assurance Flow Chart









3.2 Inspection Specification

◆Scope: The document shall be applied to TFT-LCD Module for 3.5"-15" (Ver.B01).

◆Inspection Standard: MIL-STD-105E Table Normal Inspection Single Sampling Level Ⅱ.

◆Equipment: Gauge, MIL-STD, Powertip Tester, Sample

◆Defect Level: Major Defect AQL: 0.4; Minor Defect AQL: 1.5

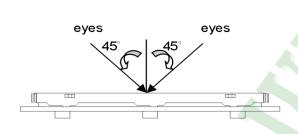
♦OUT Going Defect Level: Sampling

◆Standard of the product appearance test:

a. Manner of appearance test:

(1). The test best be under 20W×2 fluorescent light(about 300lux \sim 500lux) and distance of view must be at 30 \sim 40 cm.

(2). The test direction is base on about around 45° of vertical line.



5% Brightness

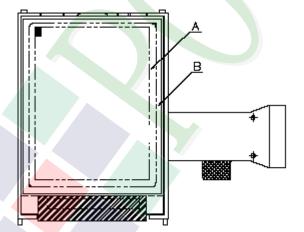
ND fliter

30~40 cm

LCD panel

2.5~3cm

(3). Definition of area.



A area: viewing area

B area: Outside of viewing area

(4). Standard of inspection: (Unit: mm)



◆Specification For TFT-LCD Module 3.5"~15":

<u>NO</u>	<u>Item</u>	<u>Criterion</u>					
		1.1 The part number is inconsistent with work order of production.	Major				
01	Product condition	1.2 Mixed product types.	Major				
		1.3 Assembled in inverse direction.	Major				
02	Quantity	2.1 The quantity is inconsistent with work order of production.					
03	Outline dimension	3.1 Product dimension and structure must conform to structure diagram.					
		4.1 Missing line character and icon.	Major				
		4.2 No function or no display.	Major				
		4.3 Display malfunction.	Major				
04	Electrical Testing	4.4 LCD viewing angle defect.					
		4.5 Current consumption exceeds product specifications.					
		4.6 Mura cannot be seen through 5% ND filter at 50% Gray, should be judged by the viewing angle of 90 degree.	Minor				
		Item Acceptance (Q'ty)					
		Bright Dot ≤ 4					
		Dot Dark Dot ≦ 5 Defect Joint Dot ≤ 3					
		Joint Dot ≤ 3					
	Dot defect	Total ≤ 7					
05	(Bright dot, Dark dot) On -display	 5.1 Inspection pattern: full white, full black, Red, Green and blue screens. 5.2 It is defined as dot defect if defect area > 1/2 dot. 5.3 The distance between two dot defect ≥ 5 mm. 5.4 Bright dot: Dots appear bright and unchanged in visible with 5% ND filter is defined. 5.5 Tiny bright dot: bright dot area ≤ 1/2 dot. a. Dots appear bright and unchanged in visible with 5% ND filter is defined defect and is judged in accordance with 6.1 b. Dots invisible with 5% ND Filter is Ignored 	Minor				



◆Specification For TFT-LCD Module 3.5″ ~15″:

NO		Criterien (Vel.201)					Lovol		
<u>NO</u>	<u>Item</u>	Criterion L 6.1 Round type (Non-display or display):					Level		
		o.1 Round type	(Ivon-alspi	ay or dis	piay):				
					Accer	otance	e (Q'ty	/)	
		Dimensio	on (diamet	<u>ter: Φ)</u>	A area		B ar		
			Ф ≦ 0.2	5	Ignore	•	,		
	Black or	0.25	$<\Phi \le 0$.	.50	5		lanc	oro	
	white		$\Phi > 0.5$	0	0		Igno) e	
	Dot, scratch,		Total		5				
	contamination	6.2 Line type(No	on-display	or displa	y):				
	Round type	<u>module</u>	Longth			Acc	ontan	ce (Q'ty)	
	\rightarrow X	size	<u>Length</u> (L)	Wid	th (W)		rea_	B area	
	V			W ≦	≦ 0.03	Ign	_		
06	$\Phi = (x+y) / 2$		L ≦10.0		$W \leq 0.05$	4	1		Minor
	$\Phi = (x+y)/2$	3.5" to less	L ≦5.0	0.05 <	W ≤ 0.10	2		Ignore	
		<u>9"</u>		W >0	0.10	As ro			
				Total	AA		5		
	Line type				0.05	Ign			
		<u>9" to 15"</u>	L ≦10.0		W ≦ 0.10	As ro		Ignore	
	✓ / ¥ W	<u> </u>		W :	>0.10	typ		ignoro	
	→			Total			5		
	L								
					Acces	otopo	o (O!t		
		Dimension	(diameter	: Ф)	Accer A area	Jlanc		<u>x)</u> area	
	Dolories		Ф ≦ 0.25		Ignore				
07	Polarizer Bubble		Φ ≤ 0.50		4				Minor
	Bubble		Ф ≦ 0.80		1		lg	nore	
		Ф	>0.80		0		J		
		To	otal		5			_	



◆Specification For TFT-LCD Module 3.5″ ~15″

▼ Spoo	illeation for it i-LCD it	(Vel.But)	
<u>NO</u>	<u>Item</u>	<u>Criterion</u>	<u>Level</u>
			Level
		$egin{array}{c cccc} \underline{X} & \underline{Y} & \underline{Z} \\ & \leq \leq a & \text{Crack can't enter} \\ & \text{viewing area} & \leq 1/2 \ t \end{array}$	
		$\leq \text{a} \qquad \begin{array}{c c} \text{Crack can't exceed the} \\ \text{half of SP width.} \end{array} \qquad \text{1/2 t} < \text{Z} \ \leq \text{2 t}$	



◆Specification For TFT-LCD Module 3.5″ ~15″: (Ver.B01)

<u>NO</u>	<u>ltem</u>	<u>Criterion</u> <u>L</u>					
		X: The length of crack Z: The thickness of crack t: The thickness of glass 8.1.2 Corner crack:					
		<u>X</u> <u>Y</u> <u>Z</u>					
		\leq 1/5 a Crack can't enter viewing area $Z \leq$ 1/2 t					
		\leq 1/5 a Crack can't exceed the half of SP width. 1/2 t $<$ Z \leq 2 t					
08	The crack of glass	8.2 Protrusion over terminal:	Minor				
		8.2.1 Chip on electrode pad: W X X X X X X X X X X X X					
		$\begin{array}{c cccc} \underline{X} & \underline{Y} & \underline{Z} \\ \hline \textbf{Front} & \leq \mathbf{a} & \leq 1/2 \ \mathbf{W} & \leq \mathbf{t} \end{array}$					

◆Specification For TFT-LCD Module 3.5″ ~15″:



NO	<u>ltem</u>	<u>Criterion</u>	Level
08	The crack of glass	Symbols: X: The length of crack Z: The thickness of crack t: The thickness of glass 8.2.2 Non-conductive portion: X X X X X X X X X X X X	Minor

◆Specification For TFT-LCD Module 3.5″ ~15″



<u>NO</u>	<u>ltem</u>	<u>Criterion</u>	<u>Level</u>
		9.1 Backlight can't work normally.	Major
09	Backlight elements	9.2 Backlight doesn't light or color is wrong.	Major
		9.3 Illumination source flickers when lit.	Major
		10.1 Pin type, quantity, dimension must match type in structure diagram.	Major
	General appearance	10.2 No short circuits in components on PCB or FPC.	Major
		10.3 Parts on PCB or FPC must be: no wrong parts, missing parts or excess parts.	Major
10		10.4 Product packaging must the same as specified on packaging specification sheet.	Minor
4		10.5 The folding and peeled off in polarizer are not acceptable.	Minor
		10.6 The PCB or FPC between B/L assembled distance (PCB or FPC) is \leq 1.5 mm.	Minor

4. Reliability Test



4.1 Reliability Test Condition

(Ver.B01)

	Tremasmey rece contained (vonzer)			
<u>NO.</u>	TEST ITEM	TEST CONDITION		
1	High Temperature Storage Test	Keep in 80 ±5°C 240 hrs		
2	Low Temperature Storage Test	Keep in -30 ±5℃ 240 hrs		
3	High Temperature / High Humidity Storage Test	Keep in 60 °C / 90% R.H duration for 240 hrs (Excluding the polarizer)		
4	Temperature Cycling Storage Test	$ \begin{array}{c} -30^{\circ}\mathbb{C} \rightarrow +25^{\circ}\mathbb{C} \rightarrow 80^{\circ}\mathbb{C} \rightarrow +25^{\circ}\mathbb{C} \\ (30_{\text{mins}}) (5_{\text{mins}}) (3_{\text{mins}}) (5_{\text{mins}}) \\ 20 \text{ Cycle} \end{array} $		
5	ESD Test	Air Discharge: Apply 2 KV with 5 times Discharge for each polarity +/- 1. Temperature ambiance: 15°C ~35°C 2. Humidity relative: 30% ~60% 3. Energy Storage Capacitance(Cs+Cd): 150pF±10% 4. Discharge Resistance(Rd): 330Ω±10% 5. Discharge, mode of operation: Single Discharge (time between successive discharges at least 1 sec) (Tolerance if the output voltage indication: ±5%)		
6	Vibration Test (Packaged)	 Sine wave 10~55 Hz frequency (1 min/sweep) The amplitude of vibration: 1.5 mm Each direction (X, Y, Z) duration for 2 hrs 		
7	Drop Test (Packaged)			

OResult Evaluation Criteria:

Under the display quality test conditions with normal operations with normal operation state. Do not change these conditions as such changes may affect practical display function.

(Normal operation state) Temperature: +20~30°C

Humidity: 50~70%

Atmospheric pressure: 86~106Kpa



5. PRECAUTION RELATING PRODUCT HANDLING

5.1 SAFETY

- 5.1.1 If the LCD panel breaks, be careful not to get the liquid crystal to touch your skin.
- 5.1.2 If the liquid crystal touches your skin or clothes, please wash it off immediately by using soap and water.

5.2 HANDLING

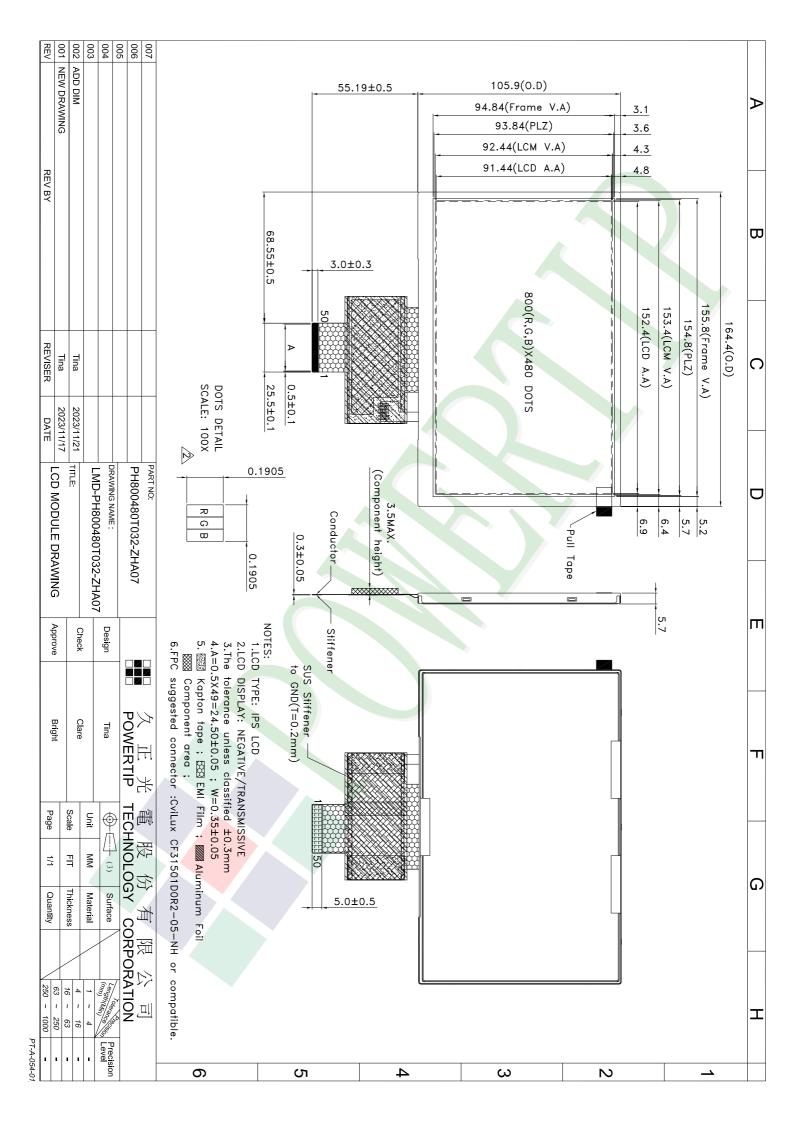
- 5.2.1 Avoid any strong mechanical shock which can break the glass.
- 5.2.2 Avoid static electricity which can damage the CMOS LSI—When working with the module, be sure to ground your body and any electrical equipment you may be using.
- 5.2.3 Do not remove the panel or frame from the module.
- 5.2.4 The polarizing plate of the display is very fragile. So, please handle it very carefully, do not touch, push or rub the exposed polarizing with anything harder than an HB pencil lead (glass, tweezers, etc.)
- 5.2.5 Do not wipe the polarizing plate with a dry cloth, as it may easily scratch the surface of plate.
- 5.2.6 Do not touch the display area with bare hands, this will stain the display area.
 - 5.2.7 Do not use ketonics solvent & aromatic solvent. Use with a soft cloth soaked with a cleaning naphtha solvent.
 - 5.2.8 To control temperature and time of soldering is 320 ± 10°C and 3-5 sec.
 - 5.2.9 To avoid liquid (include organic solvent) stained on LCM
 - 5.2.10 Caution! (LCM products with Capacitive Touch Panel)
 - Strong EMI-sources such as switch-mode power supplies (SMPS) can lead to touch malfunction (e.g. ghost-touches).
 - Therefore, the touch needs to be thoroughly tested inside the target application.
- 5.2.11 CAUTION: Continuously displaying same static image will result in high possibility of image sticking/image burn-in effect due to TFT panel characteristic.
- 5.2.12 Double-sided tape designed to be attach with the customer's mechanical device, please follow up the rules and regulations published by the original manufacturer of double-sided tape for the attachment operation.

5.3 STORAGE

- 5.3.1 Store the panel or module in a dark place where the temperature is 25°C ± 5°C and the humidity is below 65% RH.
- 5.3.2 Do not place the module near organics solvents or corrosive gases.
- 5.3.3 Do not crush, shake, or jolt the module.

5.4 TERMS OF WARRANTY

- 5.4.1 Applicable warrant period The period is within thirteen months since the date of shipping out under normal using and storage conditions.
- 5.4.2 Unaccepted responsibility
 - This product has been manufactured to your company's specification as a part for use in your company's general electronic products. It is guaranteed to perform according to delivery specifications. For any other use apart from general electronic equipment, we cannot take responsibility if the product is used in nuclear power control equipment, aerospace equipment, fire and security systems or any other applications in which there is a direct risk to human life and where extremely high levels of reliability are required.



7.7	001			Approve	Check	Contact
Ver.001 Documents NO PKG-PH800480T032-ZHA07 Packaging Specifications					Class	Tr'
Doc	uments NO. PKG-PH800480T032-ZI	HA07 Puckaging .	specifications	Bright	Clare	Tina
1.包裝材料規格表 (Packaging Material): (per carton)						
No.	Item	Model	Dimensions (mm)	1Pcs Weight	Quantity	Total Weight
1	成品 (LCM)	PH800480T032-ZHA07	164.4X105.9X5.7	0.1853	48	8.8944
2	多層薄膜(1)POF	OTFILM0BA03ABA	19"X350X0.015		6	<u> </u>
3	TRAY盤(2)Tray	TYSG000000490	352 X 260 X 15.8	0.099	30	2.97
4	舒美墊(3) EPE	FOAM000000047	350 X 255 X 5	0.011	6	0.066
5	舒美墊(4) EPE 內盒(5)Product Box	FOAM00000091 BX36627063ABBA	160X 118 X 1 383 X 270 X 66	0.0005 0.182	96	0.048
7	保利龍板(6)Polylon board	OTPLB00PL08ABA	550 X 393 X 20	0.182	2	0.0568
8	外紙箱(7)Carton	BX57041027CCBA	570 X 410 X 265	1.0	1	1.0
9	7 HOVEL (1) CALCOL	BILLYOTTOLYCOBIT	0,011,110,11200	1.0		1.0
2.一 整箱總重量 (Total LCD Weight in carton): 14.13 Kg±10%						
	箱數量規格表 (Packaging Specification)		v 20 of t			
	CM quantity per box : no per tray otal LCM quantity in carton : quant	ity per box 2	x no of tray x no of boxes	4	= 8 = 48	
(=) -		- · · · · · · · · · · · · · · · · · · ·		0	_ +0	
(4)EPE (1)多層薄膜 (6)保利龍板 POF \						
成品 (LCM) Polylon board						
Use empty tray + (2)TRAY 盤 Tray						
空盤 Tray						
			†		χ	
				(6)保利龍板 ^ Polylon board		
	' ' '			1 Olylon board	11	
Put products into the tray (3)EPE						
LCM -						
		(5)内盒 Product Box				
Trav	stacking					
A (7)外紙箱 Carton						
<u>B</u>						
特記事項(REMARK)						
		17 13 4	, (
A A A A A A A A A A A A A A A A A A A						
		ray 2				
	<u>圓</u> 角	ray 1				
4.TR 4	AY盤相疊時,需旋轉180度,請詳見B視					
Rota	te tray 180 degrees and place on top of s					
Che	ck the tray stack using Fig. B.					